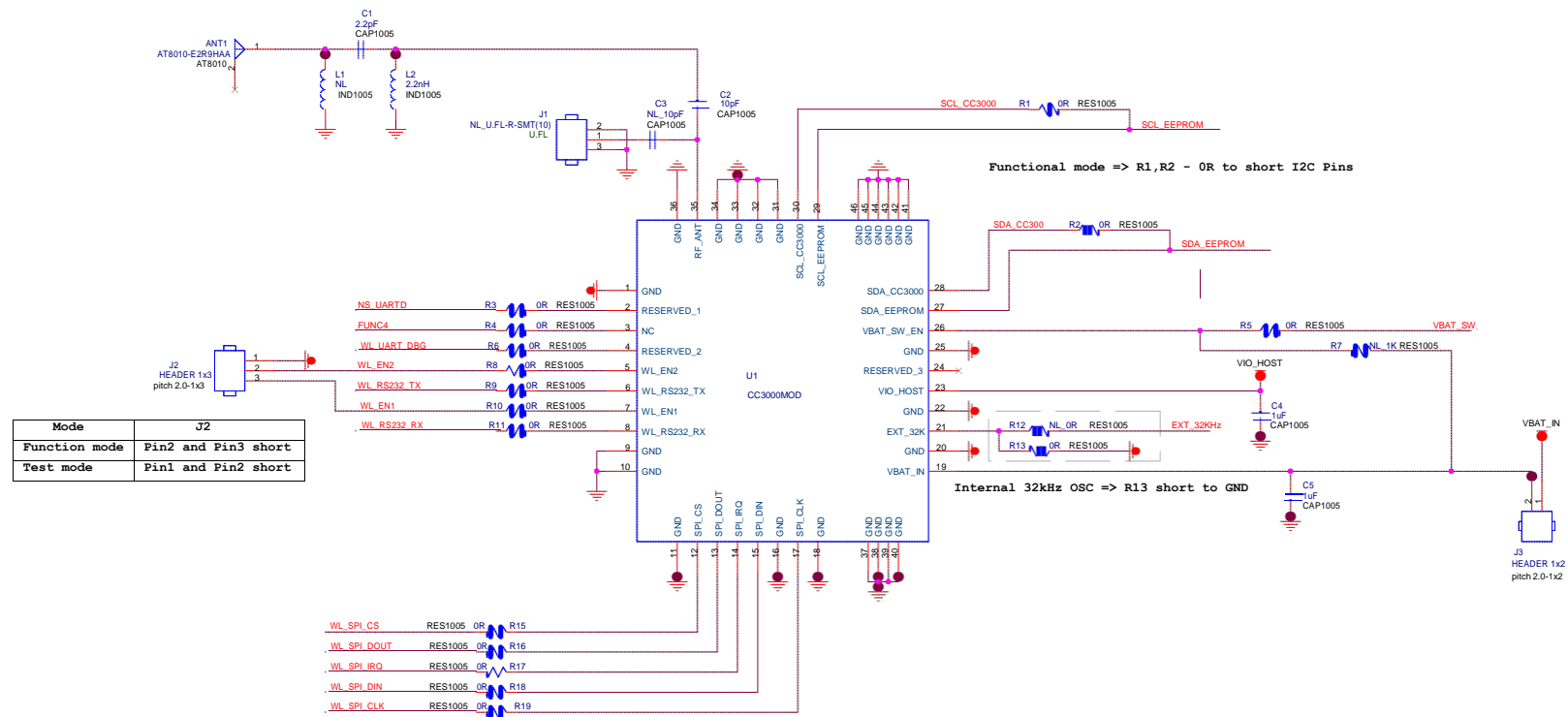
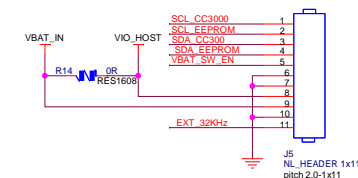
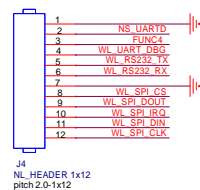


CC3000MOD Module EM Board

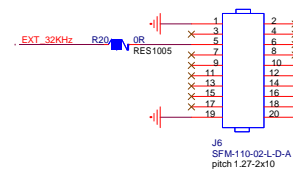


Header for Debug

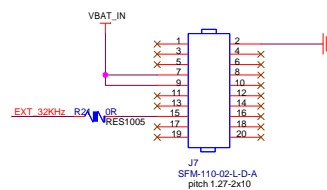


VBAT_IN: 2.7V~4.8V => 3.6V TYP
VIO_HOST: Voltage of Host Level
VBAT_IN=VIO_HOST in the EM Board and MCU case

EM Connector



Connect to RF1



Connect to RF2

Texas Instruments

Title CC3000MOD EM Board		
Size C	Document Number CC3000MOD EM Board	Rev D02
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